

°C/W

°C/W

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42

12

 $R_{\theta JC}$

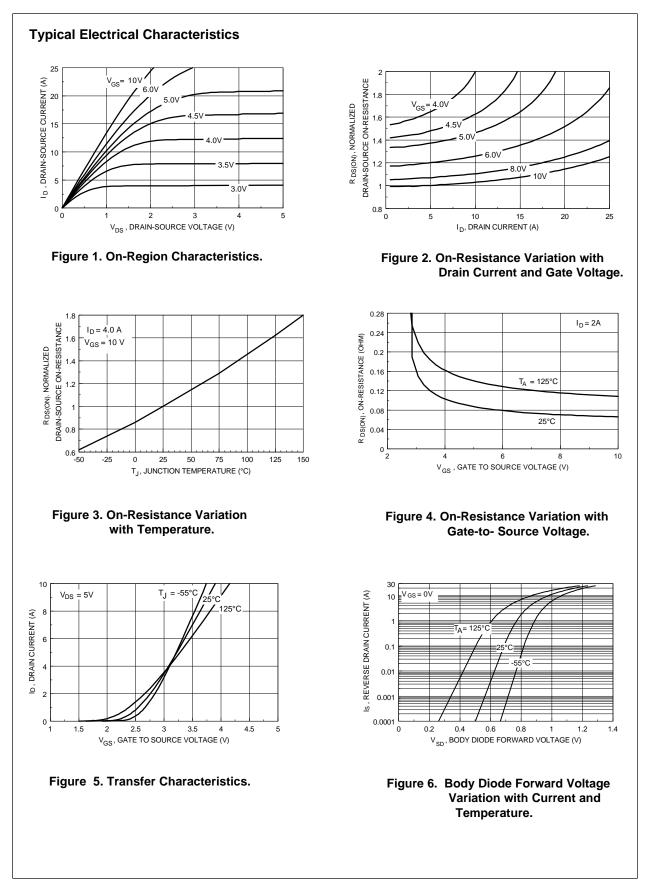
Thermal Resistance, Junction-to-Ambient (Note 1a)

(Note 1)

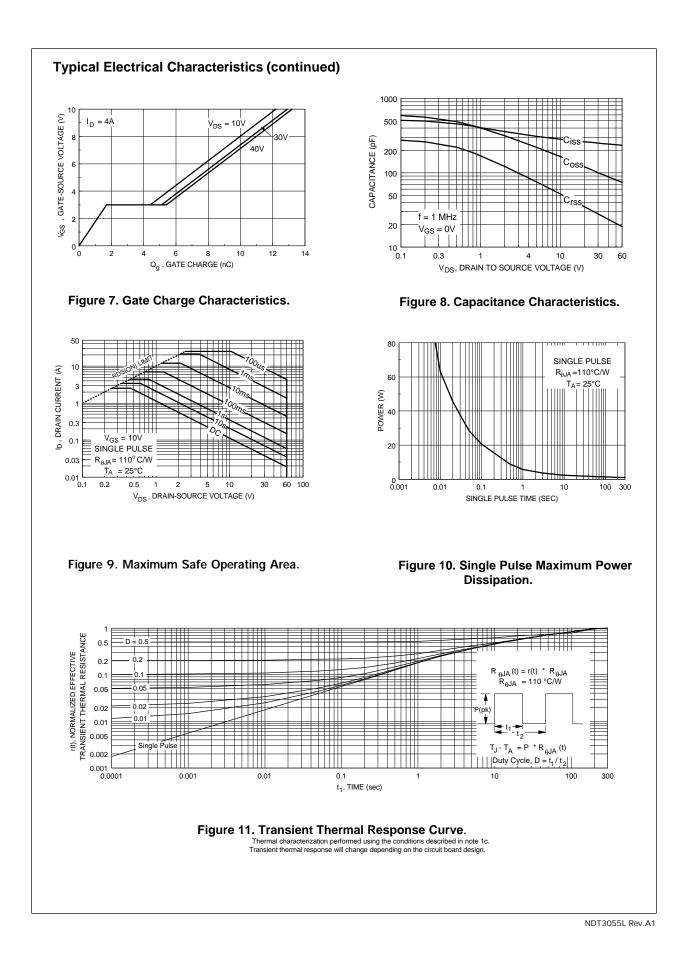
Thermal Resistance, Junction-to-Case

* Order option J23Z for cropped center drain lead.

V mV/°C 1 μA 50 μA 00 nA 00 nA	Typ Max 55 1 55 1 50 100 -100 100	Min Typ 60 55		Conditions		Symbol
mV/ ^ρ C 1 μA 50 μA 00 nA 2 V	1 50 100				RACTERISTICS	OFF CHAR/
1 μA 50 μA 00 nA 00 nA 2 V	1 50 100	55	to 25 °C	$V_{GS} = 0 V, I_{D} = 250 \mu A$	Drain-Source Breakdown Voltage	BV _{DSS}
1 μA 50 μA 00 nA 00 nA 2 V	50 100			$I_{\rm D}$ = 250 µA, Referenced to	Breakdown Voltage Temp. Coefficient	
50 μA 00 nA 00 nA 2 V	50 100			$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	Zero Gate Voltage Drain Current	DSS
00 nA 00 nA 2 V	100		T_=125°C	DS CC , GS C		DSS
00 nA 2 V			- ,	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	Gate - Body Leakage, Forward	GSSF
2 V				$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	Gate - Body Leakage, Reverse	GSSF
				63 - 7 53 -	ACTERISTICS (Note 2)	
	1.6 2	1 1.6		$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	Gate Threshold Voltage	V _{GS(th)}
	-4		to 25 °C	$I_p = 250 \mu\text{A}$, Referenced to	Gate Threshold Voltage Temp. Coefficient	$\Delta V_{GS(th)} / \Delta T_J$
	0.07 0.1	0.07		$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$	Static Drain-Source On-Resistance	
		0.125	T_=125°C	$V_{GS} = 10$ V, $V_D = 17$		R _{DS(ON)}
		0.123	1,1200	$V_{GS} = 4.5 \text{ V}, I_{D} = 3.7 \text{ A}$		
A	0.12	10		$V_{GS} = 5, V_{DS} = 10 V$	On-State Drain Current	 I
S	7	-		$V_{\rm DS} = 5 \text{ V}, \ I_{\rm D} = 4 \text{ A}$	Forward Transconductance	g _{FS}
				$v_{DS} = o v$, $v_D = 170$	CHARACTERISTICS	
pF	345	345		$V_{-1} = 25$, $V_{-1} = 0$ V	Input Capacitance	C _{iss}
pF	110			$V_{DS} = 25, V_{GS} = 0 V,$ f = 1.0 MHz	Output Capacitance	C _{oss}
pF	30				Reverse Transfer Capacitance	C _{rss}
					G CHARACTERISTICS (Note 2)	
20 ns	5 20	5		$V_{DD} = 25, I_{D} = 1 A,$	Turn - On Delay Time	D(on)
20 ns	7.5 20	7.5		$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	Turn - On Rise Time	r
50 ns	20 50	20			Turn - Off Delay Time	t _{D(off)}
20 ns	7 20	7			Turn - Off Fall Time	
20 nC	13 20	13		$V_{DS} = 40 \text{ V}, I_{D} = 4 \text{ A},$	Total Gate Charge	
nC	1.7	1.7		$V_{GS} = 10 V$	Gate-Source Charge	8
nC	3.2	3.2			Gate-Drain Charge	
1	1			MUM RATINGS	URCE DIODE CHARACTERISTICS AND MAX	·
2.5 A	2.5			ward Current	Maximum Continuous Drain-Source Diode Fo	s
.2 V	0.8 1.2	0.8	ote 2)	$V_{GS} = 0 V, I_{S} = 2.5 A$ (Note	Drain-Source Diode Forward Voltage	V _{SD}
20	13 20 1.7	13 1.7 3.2		MUM RATINGS ward Current $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.5 \text{ A}$ (Note	Total Gate Charge Gate-Source Charge Gate-Drain Charge JRCE DIODE CHARACTERISTICS AND MAX Maximum Continuous Drain-Source Diode Formation	t _f Q _{gg} Q _{gd} DRAIN-SOUI I _S V _{SD} Notes: 1. R _{p,A} is the sum



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